



## chip type power shunt resistor

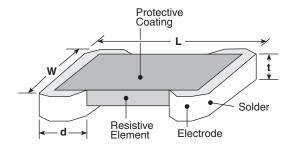


# features



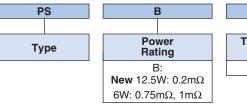
- Smooth current flow, suitable for large current detecting
- Easy to absorb the thermal expansion, because of KOA's original terminal structure
- · Low height suitable for use of thin modules
- · Automatic mounting machines are applicable
- Products with lead-free terminations meet EU RoHS and China RoHS requirements
- AEC-Q200 Qualified

#### dimensions and construction



Туре	Resist.	Dimensions inches (mm)			
(Inch Size Code)	(Ω)	L	W	d	t
PSB (4033)	0.2m	.394±.010 (10.0±0.25)	.331±.010 (8.4±0.25)		.043±.010 (1.1±0.25)
	0.75m				.026±.010
	1.0m			.118±.010 (3.0±0.25)	(0.65±0.25)

### ordering information



Т	•	
Termination Material		
T: Sn		



Nominal Resistance
All values less than $0.1\Omega$ (100m $\Omega$ ) are expressed in m $\Omega$ with "L" as decimal
Ex: $0.75m\Omega = L750$ $1m\Omega = 1L00$

1L00



For further information on packaging, please refer to Appendix A.





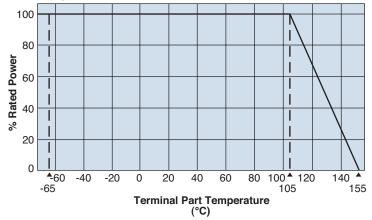
## chip type power shunt resistor

# applications and ratings

Part Designation	Power Rating	T.C.R. (ppm/°C) Max.	Resistance Range	Resistance Tolerance	Rated Terminal Part Tem- perature	Operating Temperature Range	
PSB	6W	±75	0.75m $Ω$ , $1$ m $Ω$	F: ±1%	+105°C	-65°C to +155°C	
FSB	<b>New</b> 12.5W	±100	$0.2 m\Omega$	1. ±1/6	+103 0	-03 0 10 +133 0	

## environmental applications





For resistors operated at a terminal part temperature of described for each size or above, a power rating shall be derated in accordance with the derating curve. Please refer to "Introduction of the derating curve based on the terminal part temperature" in the beginning of our catalog before use.

#### **Performance Characteristics**

	Requirement $\Delta$ R ±%			
Parameter	Limit	Typical	Test Method	
T.C.R.	Within specified T.C.R.		+25°C/+100°C	
Overload (Short time)	0.2m $\Omega$ : 1.0% 0.75m $\Omega$ , 1.0m $\Omega$ : ±0.5%	±0.1%	0.2m: 35W for 5 seconds Rated power x 2.5 for 5 seconds Use our designated aluminum circuit board & heat sink	
Resistance to Solder Heat	0.2m $\Omega$ : 1.0% 0.75m $\Omega$ , 1.0m $\Omega$ : ±0.5%	±0.2%	0.75m, 1m: 260°C ± 5°C, 10 seconds ± 1 second	
Rapid Change of Temperature	0.2m $\Omega$ : 1.0% 0.75m $\Omega$ , 1.0m $\Omega$ : ±0.5%	±0.1%	0.2m: -55°C (30 minutes), +125°C (30 minutes), 1,000 cycles 0.75m, 1.0m: -40°C (30 minutes), +125°C (30 minutes), 1,000 cycles	
Moisture Resistance	0.2mΩ: 1.0% 0.75mΩ, 1.0mΩ: $\pm 0.5\%$	±0.1%	85°C ± 2°C, 85% RH, 1000 hours, 10% Bias	
Endurance at 105°C and Less of Terminal Part Temperature	±1.0%	±0.1%	Terminal part temperature: 105°C ± 2°C, 1000 hours, 1.5 hr ON, 0.5 hr OFF cycle. Use our designated aluminum circuit board	
Low Temperature Exposure	0.2m $\Omega$ : 1.0% 0.75m $\Omega$ , 1.0m $\Omega$ : ±0.5%	±0.1%	-65°C, 96 hours	
High Temperature Exposure	±1%	±0.1%	+155°C, 1,000 hours	

Specifications given herein may be changed at any time without prior notice. Please confirm technical specifications before you order and/or use.